



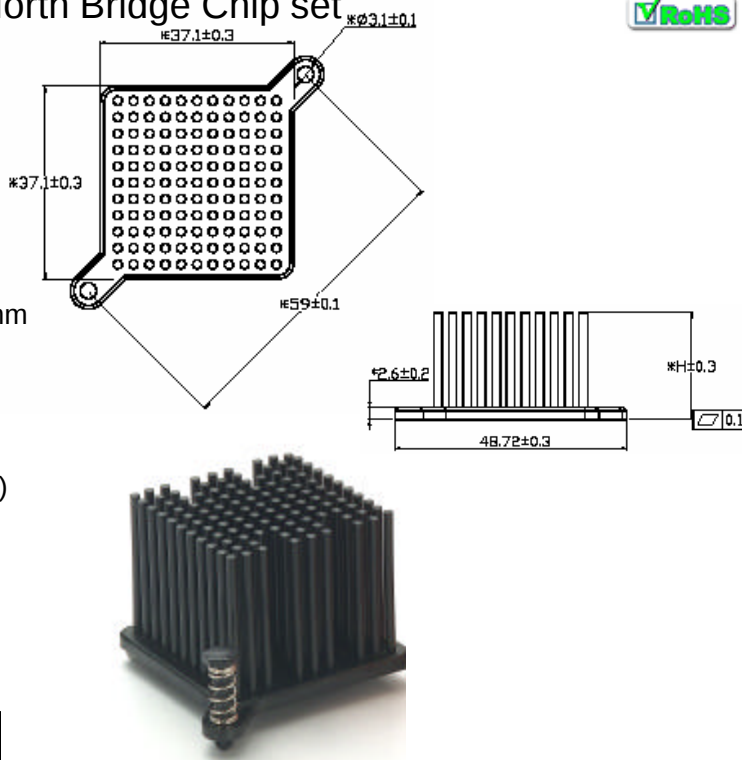
Model : CMBA024949 Series

BGA Heat Sink Specification

For North Bridge Chip set



1. Material : Al 6063
2. Dimension :
Foot print : 37.5x37.5mm
Height : 12,15,18,21,23,28,33 mm
Base (thickness) : 2.6mm
3. Finish: Black Anodize
4. Accessory :
Push Pin : Plastic (UL94-V0)
Thermal pad : T725 or others



Performance

Heat Source (LxW)	15x15
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